

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JICHEOL SHIN	12/05/2018
SEONKEUN YOO	12/05/2018
SEUNGHEE YOON	12/05/2018
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	LG DISPLAY CO., LTD.
<b>Street Address:</b>	128, YEOUNI-DAERO, YEONGDEUNGPO-GU
<b>City:</b>	SEOUL
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	07336
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16216764
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	591087.424
<b>NAME OF SUBMITTER:</b>	TOBY J. LIGON
<b>SIGNATURE:</b>	/Toby J. Ligon/
<b>DATE SIGNED:</b>	12/27/2018
<b>Total Attachments: 2</b>	
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source=424 Assignment#page2.tif	

**COMBINED DECLARATION (37 CFR 1.63) FOR U.S. PATENT APPLICATION USING AN  
APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT OF INVENTION**

<b>Title of Invention</b>	ORGANIC COMPOUND, ORGANIC LIGHT EMITTING DIODE INCLUDING THE SAME, AND ORGANIC LIGHT EMITTING DISPLAY
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**DECLARATION**

As the below named and undersigned inventor, I hereby declare that:

This declaration is directed to: ☒ The attached application, or  
☒ United States application or PCT international application number  
16/216,764 filed on December 11, 2018

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

Note to Inventor: 37 C.F.R. § 1.63(c) states: *A person may not execute an oath or declaration for an application unless that person has reviewed and understands the contents of the application, including the claims, and is aware of the duty to disclose to the Office all information known to the person to be material to patentability as defined in § 1.56.*

**ASSIGNMENT**

WHEREAS, I have made an invention described and/or claimed in the above-identified application; and

WHEREAS, LG Display Co., Ltd., a corporation of the Republic of Korea, having a place of business at 128, Yeouido-daero, Yeongdeungpo-gu, Seoul, 07336, Republic of Korea, (hereinafter referred to as "ASSIGNEE") desires to acquire the entire right, title, and interest in and to said invention in all countries throughout the world and the above-identified United States patent application;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I have assigned and do hereby assign to the ASSIGNEE, and its lawful successors and assigns, the entire right, title, and interest in and to said invention, the above-identified United States patent application and all divisions, continuations, and continuations-in-part of said application, and reissues, extensions, and renewals of Letters Patent granted thereon, and all corresponding patent applications filed in countries foreign to the United States ("foreign countries") and corresponding international patent applications, and all Letters Patents issuing on any such patent applications in the United States and foreign countries;

I hereby assign to the ASSIGNEE, and its lawful successors and assigns, the right to file patent applications in foreign countries on said invention in its own name and the right to claim priority to the above-identified United States patent application under the terms of the International Convention and any other relevant treaties;

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I hereby authorize and request the United States Patent and Trademark Office and officials in patent offices in foreign countries to issue any and all of said Letters Patent to the ASSIGNEE as the assignee of my entire right, title, and interest in and to the same, for the sole use and benefit of the ASSIGNEE, and its lawful successors and assigns, to the full end of the term for which said Letters Patent may be granted;

I hereby grant the attorney of record the power to insert on this Assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office or other authority for recordation of this document;

I hereby covenant that I have the full right to convey the interest assigned by this Assignment, and I have not executed and will not execute any agreement in conflict with this Assignment; and

Further, I hereby further covenant and agree that I will, without further consideration, communicate with the ASSIGNEE, and its lawful successors and assigns, any facts known to me respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said ASSIGNEE, and its lawful successors or assigns, execute all divisional, continuation, continuation-in-part, and reissue applications, make all rightful oaths and generally do everything possible to aid the ASSIGNEE, and its lawful successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the ASSIGNEE, and its lawful successors and assigns.

IN TESTIMONY WHEREOF, I have hereunto set my hands.

NAME OF INVENTOR (Full Legal Name): Jicheol Shin

Signature: JICHEOL SHIN Date: Dec 05, 2018

NAME OF INVENTOR (Full Legal Name): Seonkeun Yoo

Signature: SEONKEUN YOO Date: Dec 06, 2018

NAME OF INVENTOR (Full Legal Name): Seunghee Yoon

Signature: SEUNGHEE YOON Date: Dec. 07, 2018

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